
Mini Gateway Ethernet for ModFLEX Wireless Networks

FEATURES

- Compatible with all modules in the ModFLEX family
- Ethernet Interface:
 - RJ-45 connector
 - 10/100Mbps data rate
- LM3S6911 ARM Cortex M3 processor
- Small package size: 2.3" x 4.9"
- External high performance antenna
- External 5V power supply (Micro USB interface)
- Accessible micro-SD card interface
- Embedded TCP/IP Web Server

APPLICATIONS

- Lighting Control
- Sensor Networks
- Security
- HVAC Control
- Medical
- Smart Energy

DESCRIPTION

The Mini Gateway Ethernet (MGE) is a device that allows you to access your wireless network through an Ethernet interface, and supports the use of a ModFLEX module.

The wireless module in the MGE can be commanded and controlled through a IP connection using the module's host protocol.

In addition the MGE comes with an internal web server that can be accessed by any PC with an Ethernet connection. The web server can be customized via a programming development environment.

Need to get to market quickly? Not an expert in wireless? LS Research design services would be glad to develop a custom hardware or software solution for you. Contact us at sales@lsr.com or call us at 262-375-4400.



BLOCK DIAGRAM

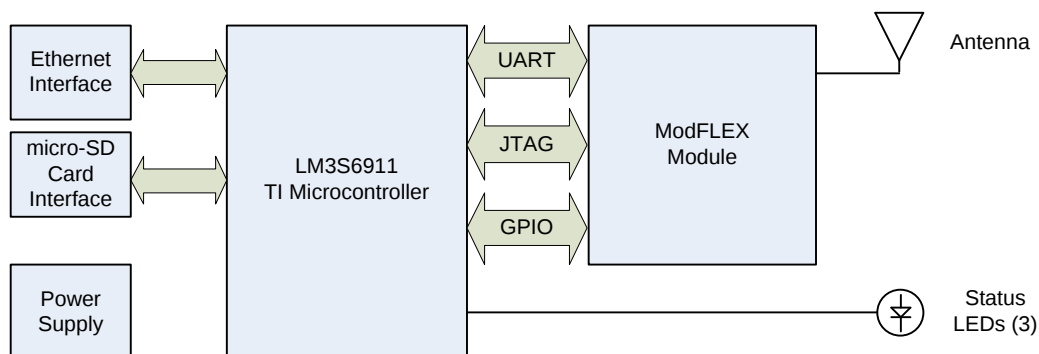


Figure 1 Mini Gateway Ethernet Block Diagram – High-Level

ORDERING INFORMATION

Order Number	Description
450-0025	ModFLEX MGE with SiFLEX02 Module
450-0101	ModFLEX MGE with ProFLEX01-R2 Module

Table 1 Mini Gateway Ethernet Model Numbers

Mini Gateway Ethernet Contents

- Mini Gateway Ethernet (MGE) with ModFLEX Transceiver Module
- External Antenna
- Ethernet Cable
- AC Wall Adapter with Micro USB Cable

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GATEWAY OVERVIEW

The MGE provides a pass-through capability for applications that require connectivity between a wireless network and an Ethernet network. Command and control of the module is achieved through the host protocol commands. See the MGE Host Protocol guide for more details. These commands can also be exercised through the ModFLEX Test Tool Suite.

The internal software architecture of the MGE consists of the following:

- FreeRTOS (Operating System)
- lwIP (light weight IP Stack)
- FatFs (FAT File System)
- HTTP Web Server
- ModFLEX Module Driver

Microcontroller

The MGE uses the Stellaris® LM3S6911 microcontroller from Texas Instruments. The Stellaris® LM3S6911 microcontroller is based on the ARM® Cortex™-M3 controller core operating at 50 MHz, with 256 kB single-cycle flash, 64 kB single-cycle SRAM, 10/100 Ethernet MAC/PHY.

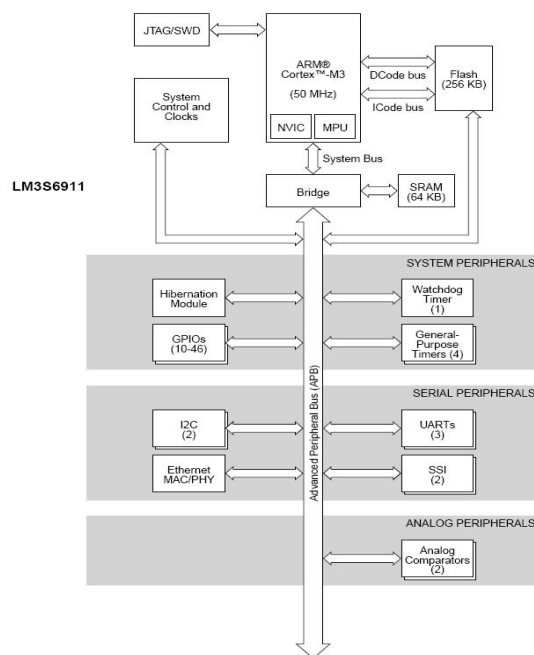


Figure 2 LM3S6911 Block Diagram

ModFLEX Module

The ModFLEX module can be any one of LSR's radio transceiver modules that are a member of the ModFLEX family of products. This includes the SiFLEX02 and ProFLEX01 modules. All ModFLEX modules are pin compatible and drop into the same PCB footprint to allow maximum flexibility.

There are three LEDs that are used to provide status to the user:

- Green – Indicates that the ModFLEX module is operational (heartbeat).
- Yellow – Indicates that there is activity on the host interface.
- Red – Indicates RF activity.

Antenna

The MGE is equipped with a high performance external antenna that can be arranged in different orientations to accommodate various mounting configurations. The environment the module is placed in will dictate the range performance. The non-ideal characteristics of the environment will result in the transmitted signal being reflected, diffracted, and scattered. All of these factors randomly combine to create extremely complex scenarios that will affect the link range in various ways.

It is also best to keep some clearance between the antenna and nearby objects. This includes how the module is mounted in the product enclosure. Unless the items on the following list of recommendations are met, the radiation pattern can be heavily distorted.

- Keep metal objects as far away from the antenna as possible.
- Do not embed the antenna in a metallic or metalized plastic enclosure.

FEATURES

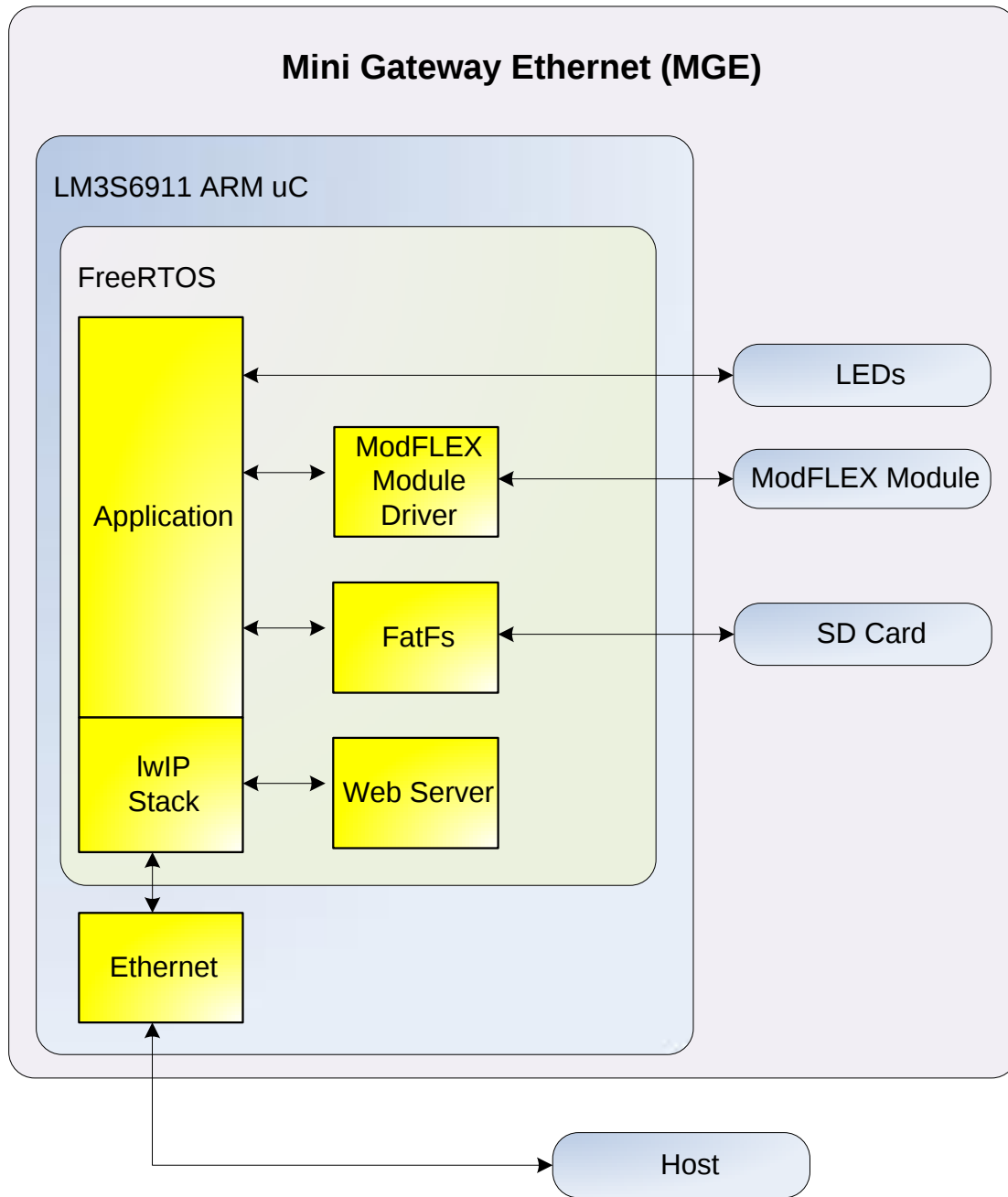


Figure 3 Mini Gateway Ethernet Architecture

Base Application

The wireless module in the MGE can be commanded and controlled through an IP connection using the module's host protocol.

The MGE sends out a UDP "I'm here" broadcast message to the network periodically. This allows other devices on the network to find or be aware of MGE device(s) on the network.

light weight IP (lwIP) Stack

This is an open source IP stack that has been ported to the MGE. See <http://savannah.nongnu.org/projects/lwip/>.

lwIP features:

- IP (Internet Protocol) including packet forwarding over multiple network interfaces
- ICMP (Internet Control Message Protocol) for network maintenance and debugging
- IGMP (Internet Group Management Protocol) for multicast traffic management
- UDP (User Datagram Protocol) including experimental UDP-lite extensions
- TCP (Transmission Control Protocol) with congestion control, RTT estimation and fast recovery/fast retransmit
- Specialized raw/native API for enhanced performance
- Optional Berkeley-like socket API
- DNS (Domain names resolver)
- SNMP (Simple Network Management Protocol)
- DHCP (Dynamic Host Configuration Protocol)
- AUTOIP / Link-local address / Zero configuration networking (for IPv4, conform with RFC 3927)
- PPP (Point-to-Point Protocol)
- ARP (Address Resolution Protocol) for Ethernet

Web Server

The default web server is shown below, and allows for configuration of the onboard module. It can be customized to meet the needs of the end application.

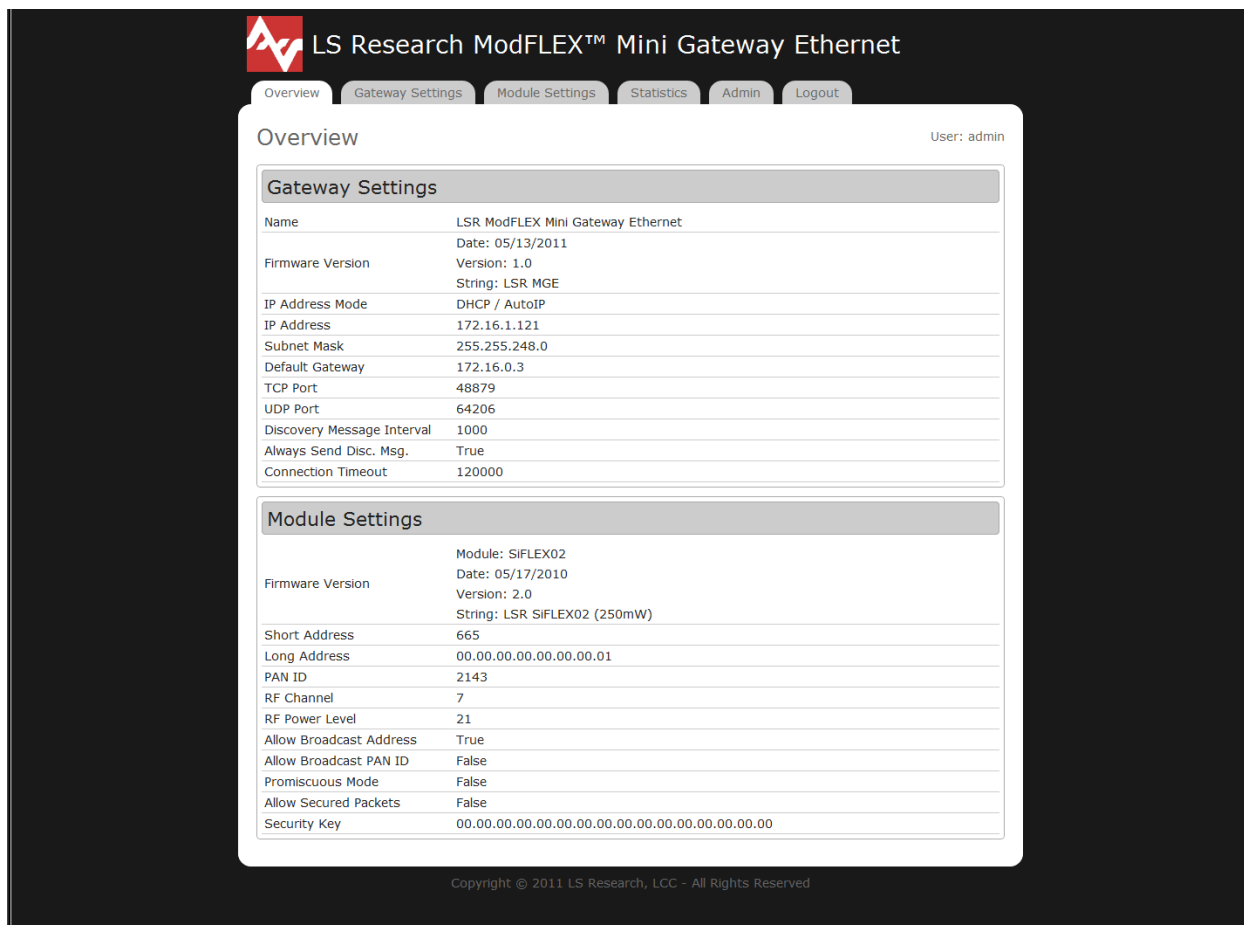


Figure 4 Web Server Home Page

FreeRTOS

This is an open source RTOS that has been ported to the MGE. More information is available at <http://www.freertos.org>.

FatFs

FatFs is an open source file system module that supports FAT32, FAT16, and FAT12 file systems. FatFs can be modified to use multiple media sources (ATA, USD, SD Card, etc.). For more information, visit the FatFs Website: http://elm-chan.org/fsw/ff/00index_e.html.

Host

Device (PC, embedded computer, etc) that communicates with the MGE over the Ethernet connection.

DEVELOPMENT TOOLS

In order to do custom firmware development on the MGE it is necessary to have the following:

- IAR Embedded Workbench for ARM (EWARM)
- J-Link Debugger
- JTAG Interface Adapter

IAR Embedded Workbench for ARM (EWARM)

IAR Embedded Workbench for the TI LM3S6911 is an integrated development environment for building and debugging embedded applications. Visit the IAR Systems website for additional information.

NOTE: At the time of this writing the LM3S6911 is listed as being offered by Luminary Micro on the IAR web site since TI recently bought Luminary Micro.

J-Link Debugger

Debug of the LM3S6911 may be accomplished with the use of the IAR J-Link debugger (Part Number: JLINK-ARM).



Figure 5 IAR J-Link

Olimex ARM-JTAG-EW Debugger

This is a cheaper alternative to the J-Link used to program and debug the LM3S6911.



Figure 6 ARM-JTAG-EW Debugger

JTAG Adapter for Stellaris® LM3S6911 Microcontroller

NOTE: The use of a small adapter is required to interface the 20-pin IAR J-Link debugger connector to the small footprint 10-pin connector on the Mini Gateway Ethernet. The JTAG adapter is available from TI as an accessory module: MDL-ADA2.



Figure 7 10-pin to 20-pin JTAG Adapter Module (P/N: MDL-ADA2)

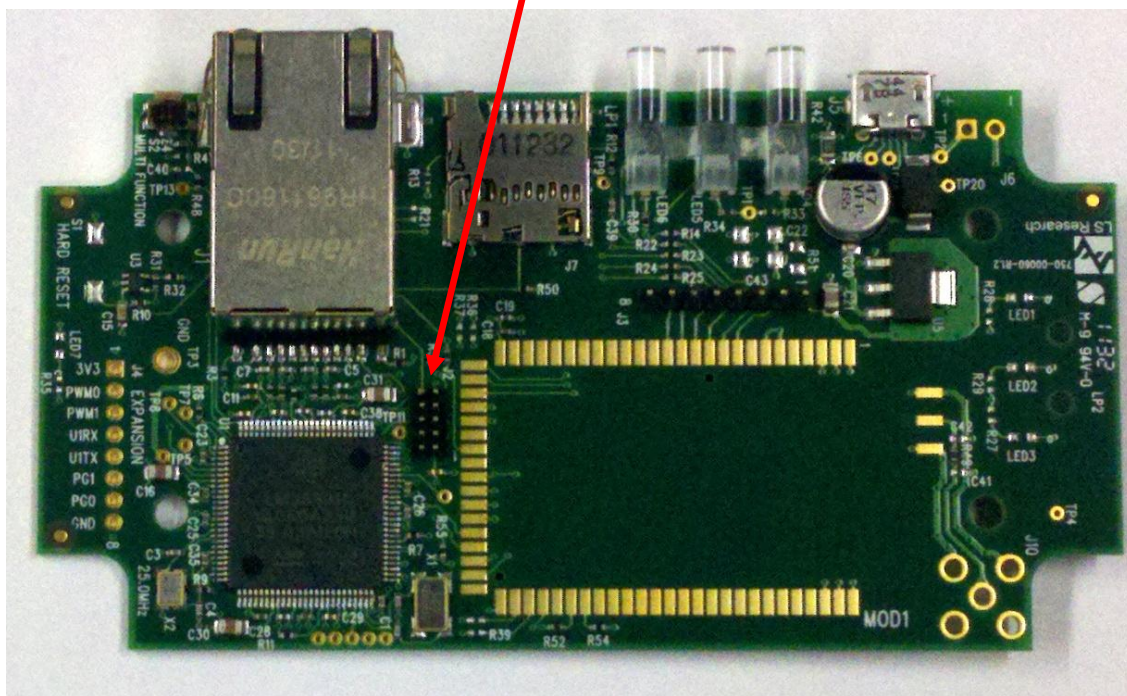


Figure 8 Stellaris JTAG Connector

UPDATING FIRMWARE ON MODULE

The firmware on the module may be updating via JTAG using J3.

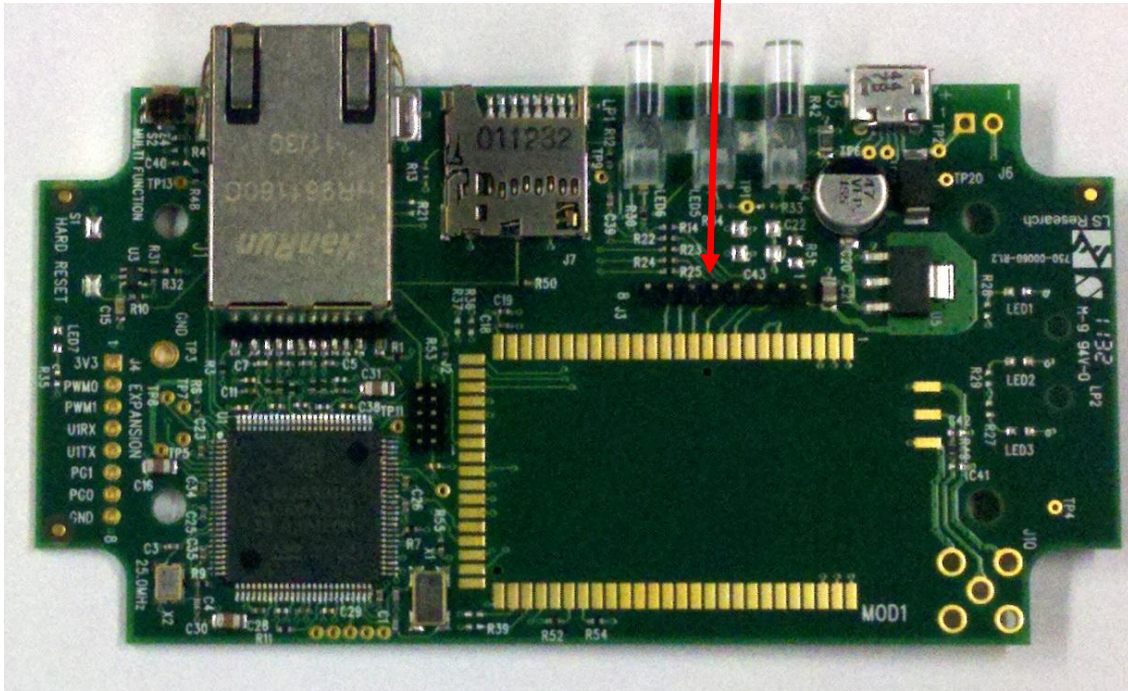


Figure 9 Module Programming Header

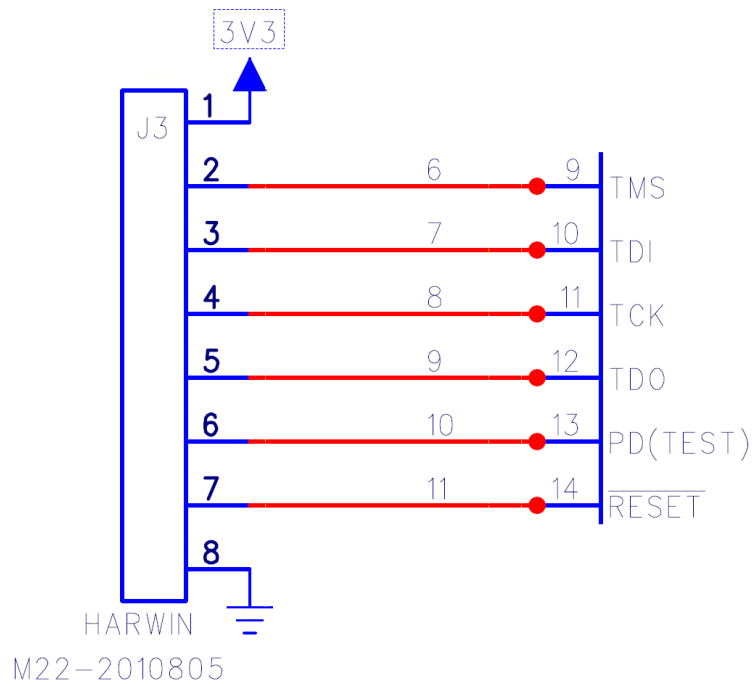


Figure 10 Programming Header Schematic

ELECTRICAL SPECIFICATIONS

Absolute Maximum Ratings

Parameter	Min	Max	Unit
Power supply voltage (VCC)	-0.3	+6.0	V
RF input power, antenna port		Note 1	dBm
RF input power, transmit port		Note 1	dBm
Operating temperature	-40	+85	°C
Storage temperature	-40	+85	°C

Table 2 Absolute Maximum Ratings¹

Recommended Operating Conditions

Parameter	Min	Typ	Max	Unit
Power supply voltage (VCC)	+4.5	5.0	+5.5	Vdc
Ambient temperature range	-40	25	70	°C

Table 3 Recommended Operating Conditions

Power Consumption

Parameter	Test Conditions	Max	Unit
Transmit mode	+25°C	550	mA
Receive mode	+25°C	350	mA

Table 4 Power Consumption

Note 1: For information that is specific to a certain ModFLEX module, please refer to the individual datasheet for that particular module.

¹ Under no circumstances should exceeding the ratings specified in the Absolute Maximum Ratings section be allowed. Stressing the module beyond these limits may result permanent damage to the module that is not covered by the warranty.

SHIPPING, HANDLING, AND STORAGE**Shipping**

The MGU is shipped in individual packages.

Handling

This product contains highly sensitive electronic circuitry. Handling without proper ESD protection may damage the unit permanently.

Storage

Do not store in salty air or in an environment with a high concentration of corrosive gas, such as Cl₂, H₂S, NH₃, SO₂, or NO_x.

Do not store in direct sunlight.

The product should not be subject to excessive mechanical shock.

AGENCY STATEMENTS

SiFLEX02

“Contains Transmitter Module FCC ID: TFB-SIFLEX2”

“Contains Transmitter Module IC: 5969A-SIFLEX2”

The OEM of the SiFLEX02 Module must only use the approved antenna(s) listed above, which have been certified with this module.

The OEM integrator has to be aware not to provide information to the end user regarding how to install or remove this RF module or change RF related parameters in the user manual of the end product.

This device is granted for use in Mobile only configurations in which the antennas used for this transmitter must be installed to provide a separation distance of at least 20cm from all person and not be co-located with any other transmitters except in accordance with FCC and Industry Canada multi-transmitter product procedures.

ProFLEX02-R2

“Contains Transmitter Module FCC ID: TFB-PROFLEX1”

“Contains Transmitter Module IC: 5969A-PROFLEX1”

The OEM of the ProFLEX01 Module must only use the approved antenna(s) listed above, which have been certified with this module.

The OEM integrator has to be aware not to provide information to the end user regarding how to install or remove this RF module or change RF related parameters in the user manual of the end product.

This device is granted for use in Mobile only configurations in which the antennas used for this transmitter must be installed to provide a separation distance of at least 20cm from all person and not be co-located with any other transmitters except in accordance with FCC and Industry Canada multi-transmitter product procedures.

AGENCY CERTIFICATIONS

This device is FCC and IC certified; see the appropriate module (ProFLEX01-R2 or SiFLEX02) for specifics.

This device is CE certified with the ProFLEX01-R2 module.

EUROPE – PROFLEX01-R2

CE Notice

This device has been tested and certified for use in the European Union. See the Declaration of Conformity (DOC) for specifics.

Declaration of Conformity (DOC)

The DOC can be downloaded from the LSR Wiki.

MECHANICAL DATA

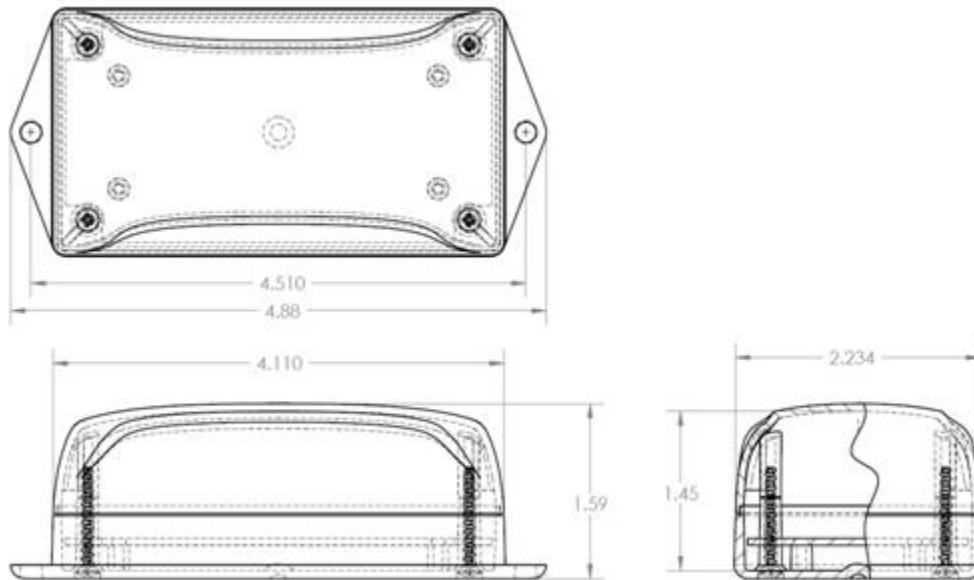


Figure 11 Enclosure Envelope

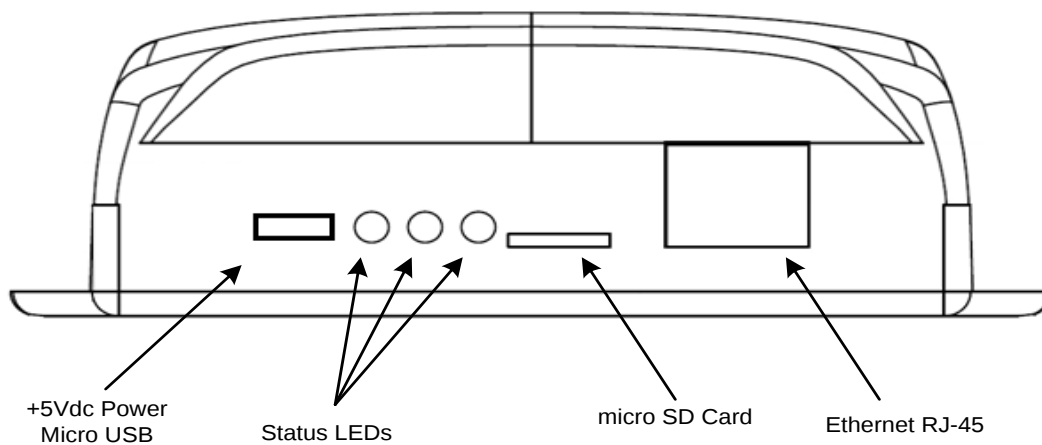
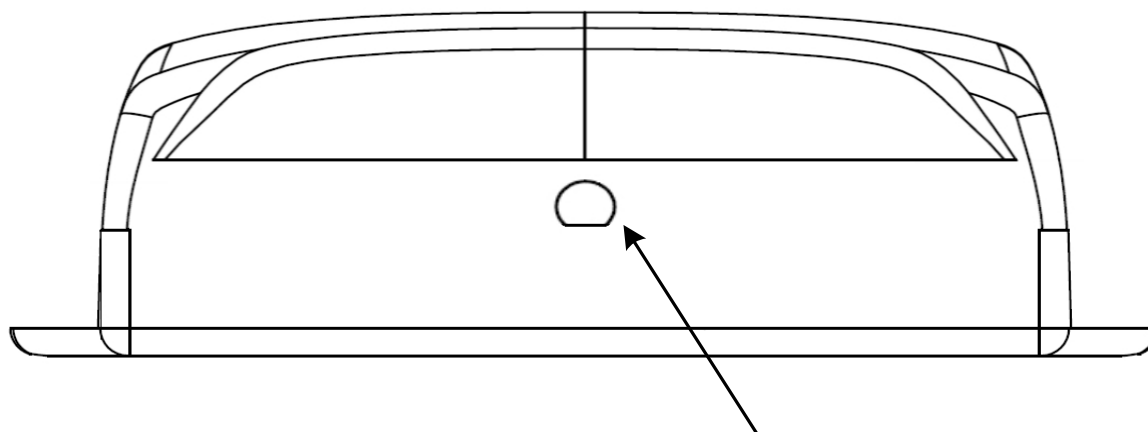


Figure 12 Mini Gateway Ethernet Front Port Identification



Antenna Port

Figure 13 Mini Gateway Ethernet Rear Port Identification

PRODUCT REVISION HISTORY

450-0025 SiFLEX02 MGE

- Rev 3: Initial production release.

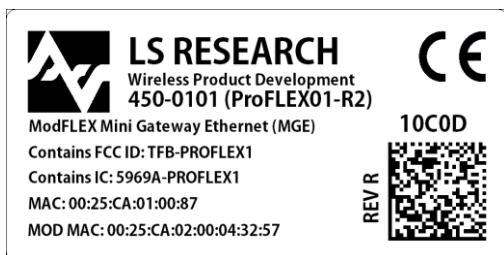


450-0101 ProFLEX01-R2 MGE

- Rev 1: Initial production release.



- Rev 1.1: Added the “CE” mark to the label.
 Previous versions are also CE certified, although they don’t have the CE Mark on the label.



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